

STIEC45-XXAS

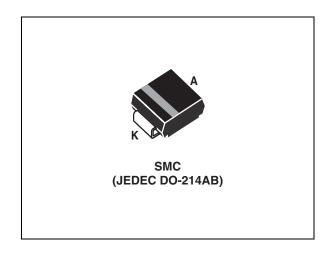
Transil[™] for IEC 61000-4-5 compliance

Features

- Peak pulse current: 500 A (8/20 μs, 1.2/50 μs)
- Stand off voltage range: from 24 V to 33 V
- Unidirectional types
- Low leakage current
 - 0.2 µA at 25 °C
 - 1 µA at 85 °C
- Operating T_i max: 150 °C
- High peak current capability at T_j max : 410 A 8/20 μs
- JEDEC registered package outline

Complies with the following standards

- IEC 61000-4-2 level 4
 - 15 kV (air discharge)
 - 8 kV (contact discharge)
- MIL STD 883G Method 3015-7 Class 3B
 - 25 kV HBM (human body model)
- IEC 61000-4-5
 - Level 4 4 kV with R = 12 Ω (334 A) common mode
 - Level 2 1 kV with R = 2 Ω (500 A) differential mode
- MIL STD 883G, method 3015-7 Class 3B
 -25 kV HBM (human body model)
- Resin meets UL 94, V0
- MIL-STD-750, method 2026 soldererabilty
- EIA STD RS-481 and IEC 60286-3 packing
- IPC 7531 footprint



Description

The STIEC45 Transil series has been designed to protect DC power supply lines according to IEC 61000-4-5. This device protects circuits against electrical fast transients (EFT) according to IEC 61000-4-4 and ETS EN 300 386. Protection against electrostatic discharges is provided according to IEC 61000-4-2 and MIL STD 883 Method 3015.

Planar technology makes these devices suitable for high-end equipment and SMPS where low leakage current and high junction temperature are required to provide reliability and stability over time.

The STIEC45 device is packaged in SMC (SMC footprint in accordance with IPC 7351 standard).

TM: Transil is a trademark of STMicroelectronics

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Characteristics STIEC45-XXAS

1 Characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25 \, ^{\circ}C$)

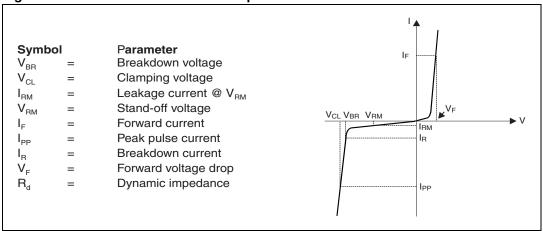
Symbol	Parameter	Value	Unit	
I_{PP}	Peak pulse current ⁽¹⁾ (8/20 μ s, 1.2/50 μ s)	500	Α	
T _{stg}	Storage temperature range	-65 to +150	°C	
T _j	Operating junction temperature range	-55 to +150	°C	
TL	Maximum lead temperature for soldering during 10	260	°C	

^{1.} For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Thermal resistances

Symbol	Parameter	Value	Unit
R _{th(j-l)}	Junction to leads	15	°C/W
R _{th(j-a)}	Junction to ambient on printed circuit on recommended pad layout	90	°C/W

Figure 1. Electrical characteristics - parameters



STIEC45-XXAS Characteristics

Table 3. Electrical characteristics - parameter values ($T_{amb} = 25$ °C)

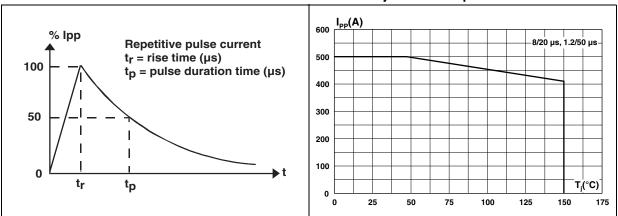
	I _{RM} @V _{RM}			V _{BR} @I _R ⁽¹⁾			V _{CL} @I _{PP} 8/20 μs, 1.2/50 μs		R _D ⁽²⁾ 8/20 μs	α T ⁽³⁾	
Order code	25 °C	85 °C		Min.	Тур.	Max.		Max.		Тур.	max
	μ	A	٧		٧		mA	٧	Α	Ω	10 ⁻⁴ / °C
STIEC45-24AS	0.2	1	24	26.7	28.2	29.5	1	42	500	0.025	9.6
STIEC45-26AS	0.2	1	26	28.9	30.3	31.9	1	45	500	0.026	9.7
STIEC45-27AS	0.2	1	27	30	31.6	33.2	1	47	500	0.028	9.7
STIEC45-28AS	0.2	1	28	31.1	32.6	34.3	1	49	500	0.029	9.8
STIEC45-30AS	0.2	1	30	33.3	35	36.8	1	55	500	0.036	9.9
STIEC45-33AS	0.2	1	33	36.7	38.6	40.6	1	59	500	0.036	10

- 1. Pulse test: $t_p < 50 \text{ ms}$
- 2. To calculate maximum clamping voltage at other surge levels: $V_{CLmax} = R_D x I_{PP} + V_{BRmax}$
- 3. To calculate V_{BR} versus junction temperature: V_{BR} @ $T_j = V_{BR}$ @ 25° C x (1 + α T x ($T_j 25$))

Note: Surge capability given for both directions for unidirectional and bidirectional types.

Figure 2. Pulse form

Figure 3. Peak pulse current versus initial junction temperature



Characteristics STIEC45-XXAS

Figure 4. Clamping voltage at 500 A (1.2/50 μ s - 8/20 μ s)

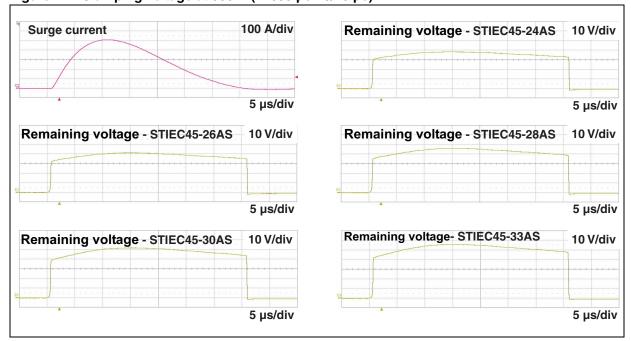
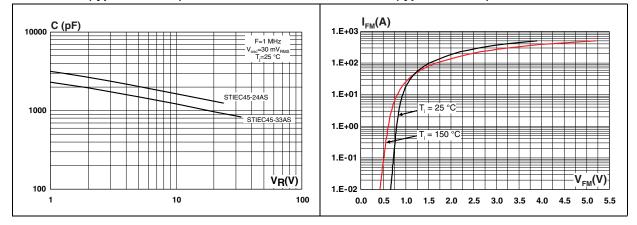


Figure 5. Junction capacitance versus reverse applied voltage (typical values)

Figure 6. Peak forward voltage drop versus peak forward current (typical values)

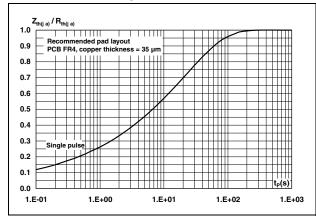


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Figure 7. Relative variation of thermal impedance, junction to ambient, versus pulse duration

Figure 8. Thermal resistance junction to ambient versus copper surface under each lead



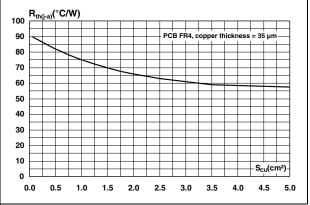
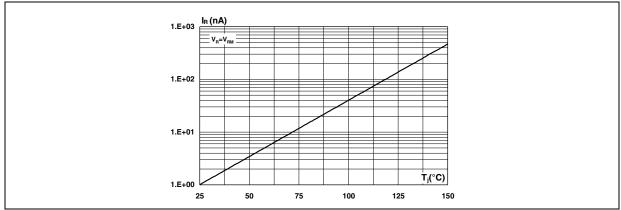
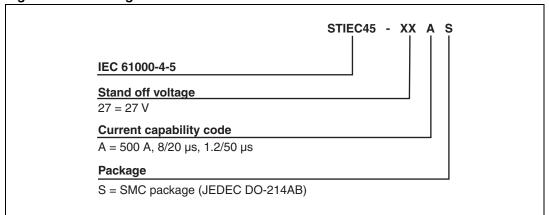


Figure 9. Leakage current versus junction temperature (typical values)



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

- Case: JEDEC DO-214AB molded plastic over planar junction
- Terminals: solder plated, solderable per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Flammability: epoxy is rated UL94V-0
- RoHS package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 4. SMC dimensions

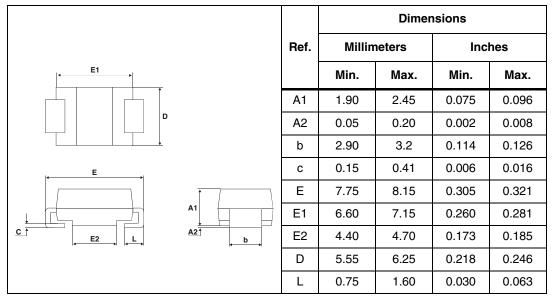
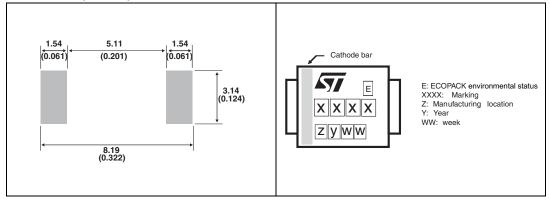


Figure 11. Footprint dimensions in mm Figure 12. Marking layout (inches)



Note: Marking layout can vary according to assembly location.

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4 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode		
STIEC45-24AS	4524A		0.25 g	2500			
STIEC45-26AS	4526A				Tape and reel		
STIEC45-27AS	4527A	SMC					
STIEC45-28AS	4528A						
STIEC45-30AS	4530A						
STIEC45-33AS	4533A						

5 Revision history

Table 6. Document revision history

Date	Revision	Changes
07-Dec-2009	1	First issue.

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